Sir:

Transmitted herewith for filing is the Patent Application of:

| Company | C XIAN BIN WANG

A NEW DESIGN AND METHOD OF FABRICATION OF A DIE OXIDE RING

0							
Enclosed are:							
x	4 sheets of drawing(s) - formal.						
$\mathbf{x}$	An assignment of the invention to Chartered Semiconductor Manufacturing Ltd.						
	An associate power of attorney Applicant claims small entity status						
	Request & Certification under 35 USC 122(b)(2)(b)(i)						
The filing fee has been calculated as shown below:							
		(Col. 1)	(Col. 2)	OTHER THAN	A SMALL ENTITY		
FOR:		NO. FILED	NO. EXTRA	RATE	FEE		
BASIC	FEE	$\mathbf{X}$	>>		\$ 770.	,	
TOTAL	L CLAIMS	9 -20=	0	x 18 =	\$ 0.		
	CLAIMS	3 -3=	0	x 86 =	\$ 0.		
				SUB TOTAL	\$ 770.		
			-	ASSIGNMENT	\$40.		
			-				
x	Places charge my Denocit Account No. 10,0023 in the amount of \$ 910. A duplicate conv. of this cheet is analoged						
$\mathbf{x}$	_	Please charge my Deposit Account No. 19-0033 in the amount of \$ 810. A duplicate copy of this sheet is enclosed.					
The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit overpayment to Deposit Account No. 19-0033. A duplicate copy of this sheet is enclosed.  X Any additional filing fees required under 37 CFR §1.16.						unication or credit any	
	X Any patent application processing fees under 37 CFR §1.17.						
	Respectfully submitted,						

## **EXPRESS MAIL CERTIFICATE**

Express Mail No.EV319113625US

I hereby certify that this correspondence is being deposited with the United States Postal Service as Express Mail in an envelope addressed to Assistant Commissioner of Patents, Alexandria, VA, 22313-1450. Applicant and/or Attorney requests the date of deposit as the Filing Date.

Signature / Date

ACKERMAN, REG. NO. 37,761